

# KSP05/06

## **Amplifier Transistor**

- Collector-Emitter Voltage: V<sub>CEO</sub> = KSP05: 60V
- Collector Dissipation: P<sub>C</sub> (max)=625mW
  Complement to KSP55/56



# **NPN Epitaxial Silicon Transistor**

## **Absolute Maximum Ratings** T<sub>a</sub>=25°C unless otherwise noted

Symbol	Parameter	Value	Units
$V_{CBO}$	Collector Base Voltage		
	: KSP05	60	V
	: KSP06	80	V
V <sub>CEO</sub>	Collector-Emitter Voltage		
	: KSP05	60	V
	: KSP06	80	V
$V_{EBO}$	Emitter-Base Voltage	4	V
l <sub>C</sub>	Collector Current	500	mA
P <sub>C</sub>	Collector Power Dissipation	625	mW
T <sub>J</sub>	Junction Temperature	150	°C
T <sub>STG</sub>	Storage Temperature	-55~150	°C

## Electrical Characteristics T<sub>a</sub>=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Max.	Units
BV <sub>CEO</sub>	Collector-Emitter Breakdown Voltage	I <sub>C</sub> =1mA, I <sub>B</sub> =0			
	: KSP05		60		V
	: KSP06		80		V
BV <sub>EBO</sub>	Emitter-Base Breakdown Voltage	I <sub>E</sub> =100μA, I <sub>C</sub> =0	4		V
I <sub>CBO</sub>	Collector Cut-off Current				
	: KSP05	$V_{CB}$ =60V, $I_{E}$ =0		0.1	μΑ
	: KSP06	V <sub>CB</sub> =80V, I <sub>E</sub> =0		0.1	μΑ
I <sub>CEO</sub>	Collector Cut-off Current	V <sub>CE</sub> =60V, I <sub>B</sub> =0		0.1	μΑ
h <sub>FF</sub>	DC Current Gain	V <sub>CE</sub> =1V, I <sub>C</sub> =10mA	50		
		V <sub>CE</sub> =1V, I <sub>C</sub> =100mA	50		
V <sub>CE</sub> (sat)	Collector-Emitter Saturation Voltage	I <sub>C</sub> =100mA, I <sub>B</sub> =10mA		0.25	V
V <sub>BE</sub> (on)	Base-Emitter On Voltage	V <sub>CE</sub> =1V, I <sub>C</sub> =100mA		1.2	V
f <sub>T</sub>	Current Gain Bandwidth Product	V <sub>CE</sub> =2V, I <sub>C</sub> =10mA f=100MHz	100		MHz

<sup>\*</sup> Pulse Test: PW≤300μs, Duty Cycle≤2%

# **Typical Characteristics**

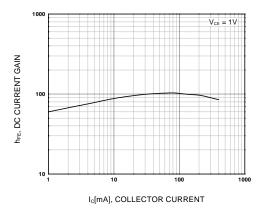


Figure 1. DC current Gain

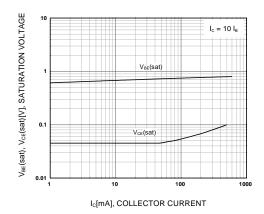


Figure 2. Collector-Emitter Saturation Voltage Base-Emitter Saturation Voltage

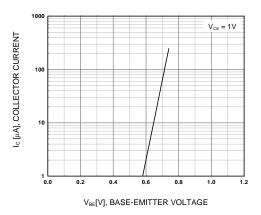


Figure 3. Base-Emitter On Voltage

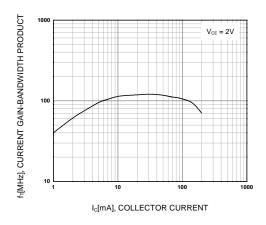
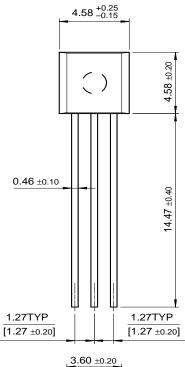


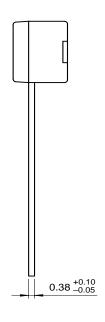
Figure 4. Current Gain Bandwidth Product

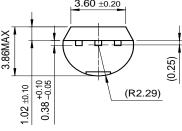


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